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Understanding <u>Embedded - CPLDs (Complex</u> <u>Programmable Logic Devices)</u>

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixedfunction ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details

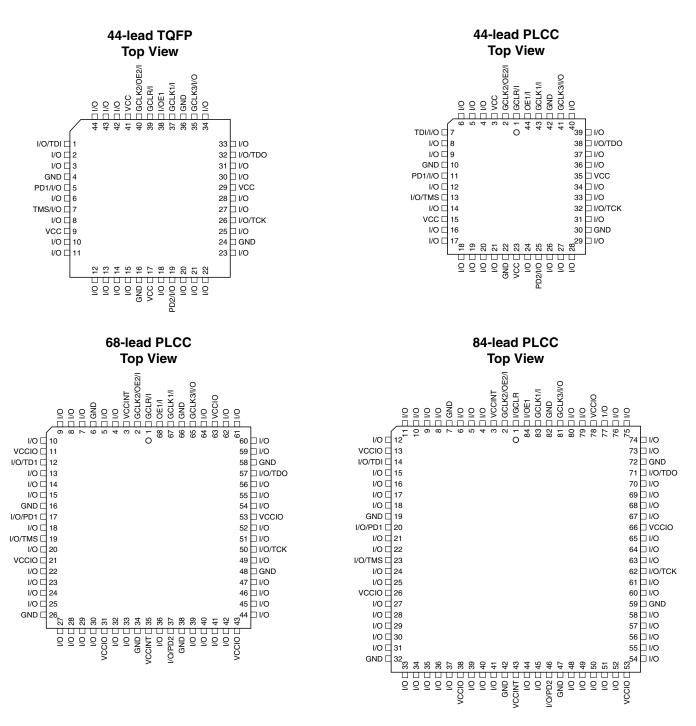
E·XFI

2 0 0 0 0 0	
Product Status	Obsolete
Programmable Type	In System Programmable (min 10K program/erase cycles)
Delay Time tpd(1) Max	15 ns
Voltage Supply - Internal	3V ~ 3.6V
Number of Logic Elements/Blocks	-
Number of Macrocells	64
Number of Gates	-
Number of I/O	32
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/atf1504asv-15ac44

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong







Description

The ATF1504ASV(L) is a high-performance, high-density complex programmable logic device (CPLD) that utilizes Atmel's proven electrically-erasable memory technology. With 64 logic macrocells and up to 68 inputs, it easily integrates logic from several TTL, SSI, MSI, LSI and classic PLDs. The ATF1504ASV(L)'s enhanced routing switch matrices increase usable gate count and the odds of successful pin-locked design modifications.

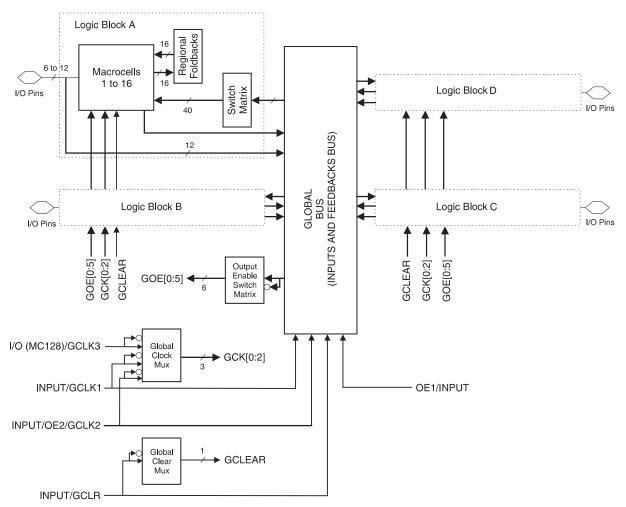
The ATF1504ASV(L) has up to 68 bi-directional I/O pins and four dedicated input pins, depending on the type of device package selected. Each dedicated pin can also serve as a global control signal, register clock, register reset or output enable. Each of these control signals can be selected for use individually within each macrocell.

Each of the 64 macrocells generates a buried feedback that goes to the global bus. Each input and I/O pin also feeds into the global bus. The switch matrix in each logic block then selects 40 individual signals from the global bus. Each macrocell also generates a foldback logic term that goes to a regional bus. Cascade logic between macrocells in the ATF1504ASV(L) allows fast, efficient generation of complex logic functions. The ATF1504ASV(L) contains four such logic chains, each capable of creating sum term logic with a fan-in of up to 40 product terms.

The ATF1504ASV(L) macrocell, shown in Figure 1, is flexible enough to support highlycomplex logic functions operating at high speed. The macrocell consists of five sections: product terms and product term select multiplexer, OR/XOR/CASCADE logic, a flip-flop, output select and enable, and logic array inputs.

4 **ATF1504ASV(L)**

Block Diagram



Unused product terms are automatically disabled by the compiler to decrease power consumption. A security fuse, when programmed, protects the contents of the ATF1504ASV(L). Two bytes (16 bits) of User Signature are accessible to the user for purposes such as storing project name, part number, revision or date. The User Signature is accessible regardless of the state of the security fuse.

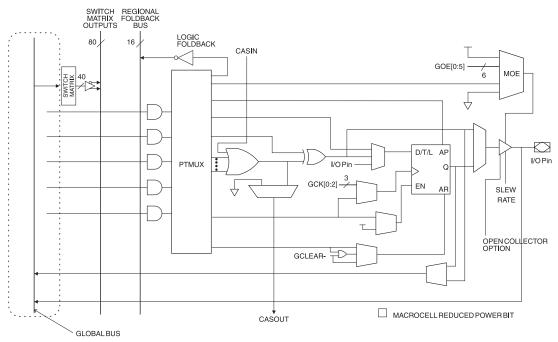
The ATF1504ASV(L) device is an in-system programmable (ISP) device. It uses the industry-standard 4-pin JTAG interface (IEEE Std. 1149.1), and is fully-compliant with JTAG's Boundary-scan Description Language (BSDL). ISP allows the device to be programmed without removing it from the printed circuit board. In addition to simplifying the manufacturing flow, ISP also allows design modifications to be made in the field via software.

Product Terms and SelectEach ATF1504ASV(L) macrocell has five product terms. Each product term receives as
its inputs all signals from both the global bus and regional bus.

The product term select multiplexer (PTMUX) allocates the five product terms as needed to the macrocell logic gates and control signals. The PTMUX programming is determined by the design compiler, which selects the optimum macrocell configuration.



Figure 1. ATF1504ASV(L) Macrocell



Programmable Pin-keeper Option for Inputs and I/Os

The ATF1504ASV(L) offers the option of programming all input and I/O pins so that pin keeper circuits can be utilized. When any pin is driven high or low and then subsequently left floating, it will stay at that previous high- or low-level. This circuitry prevents unused input and I/O lines from floating to intermediate voltage levels, which causes unnecessary power consumption and system noise. The keeper circuits eliminate the need for external pull-up resistors and eliminate their DC power consumption.



	All power-down AC characteristic parameters are computed from external input or I/O pins, with reduced-power bit turned on. For macrocells in reduced-power mode (reduced-power bit turned on), the reduced-power adder, t_{RPA} , must be added to the AC parameters, which include the data paths t_{LAD} , t_{LAC} , t_{IC} , t_{ACH} and t_{SEXP} .
	The ATF1504ASV(L) macrocell also has an option whereby the power can be reduced on a per macrocell basis. By enabling this power-down option, macrocells that are not used in an application can be turned down, thereby reducing the overall power con- sumption of the device.
	Each output also has individual slew rate control. This may be used to reduce system noise by slowing down outputs that do not need to operate at maximum speed. Outputs default to slow switching, and may be specified as fast switching in the design file.
Design Software Support	ATF1504ASV(L) designs are supported by several industry standard third party tools. Automated fitters allow logic synthesis using a variety of high-level description lan- guages and formats.
Power-up Reset	 The ATF1504ASV is designed with a power-up reset, a feature critical for state machine initialization. At a point delayed slightly from V_{CC} crossing V_{RST}, all registers will be initialized, and the state of each output will depend on the polarity of its buffer. However, due to the asynchronous nature of reset and uncertainty of how V_{CC} actually rises in the system, the following conditions are required: 1. The V_{CC} rise must be monotonic, 2. After reset occurs, all input and feedback setup times must be met before driving the clock pin high, and,
	3. The clock must remain stable during T_{D} .
	The ATF1504ASV has two options for the hysteresis about the reset level, V _{RST} , Small and Large. To ensure a robust operating environment in applications where the device is operated near 3.0V, Atmel recommends that during the fitting process users configure the device with the Power-up Reset hysteresis set to Large. For conversions, Atmel POF2JED users should include the flag "-power_reset" on the command line after "file-name.POF". To allow the registers to be properly reinitialized with the Large hysteresis option selected, the following condition is added:
	 If V_{CC} falls below 2.0V, it must shut off completely before the device is turned on again.
	When the Large hysteresis option is active, I _{CC} is reduced by several hundred micro- amps as well.
Security Fuse Usage	A single fuse is provided to prevent unauthorized copying of the ATF1504ASV(L) fuse patterns. Once programmed, fuse verify is inhibited. However, the 16-bit User Signature remains accessible.



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Programming	ATF1504ASV(L) devices are in-system programmable (ISP) devices utilizing the 4-pin JTAG protocol. This capability eliminates package handling normally required for pro- gramming and facilitates rapid design iterations and field changes.
	Atmel provides ISP hardware and software to allow programming of the ATF1504ASV(L) via the PC. ISP is performed by using either a download cable, a comparable board tester or a simple microprocessor interface.
	To facilitate ISP programming by the Automated Test Equipment (ATE) vendors. Serial Vector Format (SVF) files can be created by Atmel provided software utilities.
	ATF1504ASV(L) devices can also be programmed using standard third-party program- mers. With third-party programmer the JTAG ISP port can be disabled thereby allowing four additional I/O pins to be used for logic.
	Contact your local Atmel representatives or Atmel PLD applications for details.
ISP Programming Protection	The ATF1504ASV(L) has a special feature that locks the device and prevents the inputs and I/O from driving if the programming process is interrupted for any reason. The inputs and I/O default to high-Z state during such a condition. In addition the pin keeper option preserves the former state during device programming, if this circuit were previ- ously programmed on the device. This prevents disturbing the operation of other circuits in the system while the ATF1504ASV(L) is being programmed via ISP.
	All ATF1504ASV(L) devices are initially shipped in the erased state thereby making them ready to use for ISP.
	Note: For more information refer to the "Designing for In-System Programmability with Atmel CPLDs" application note.

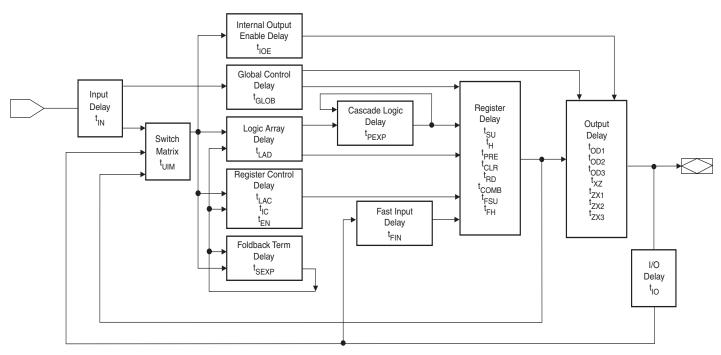


Absolute Maximum Ratings*

Temperature Under Bias40°C to +85°C
Storage Temperature65°C to +150°C
Voltage on Any Pin with Respect to Ground2.0V to +7.0V ⁽¹⁾
Voltage on Input Pins with Respect to Ground During Programming2.0V to +14.0V ⁽¹⁾
Programming Voltage with Respect to Ground2.0V to +14.0V ⁽¹⁾

Timing Model

- *NOTICE: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
- Note: 1. Minimum voltage is -0.6V DC, which may undershoot to -2.0V for pulses of less than 20 ns. Maximum output pin voltage is V_{CC} + 0.75V DC, which may overshoot to 7.0V for pulses of less than 20 ns.





AC Characteristics (Continued)

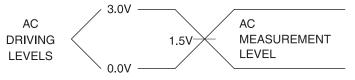
			-15		-20	
Symbol	Parameter	Min	Мах	Min	Max	Units
t _{ZX2}	Output Buffer Enable Delay (Slow slew rate = OFF; V_{CCIO} = 3.3V; C_L = 35 pF)		7		9	ns
t _{ZX3}	Output Buffer Enable Delay (Slow slew rate = ON; $V_{CCIO} = 5.0V/3.3V$; $C_L = 35 \text{ pF}$)		10 11 ns			ns
t _{xz}	Output Buffer Disable Delay ($C_L = 5 \text{ pF}$)		6		7	ns
t _{SU}	Register Setup Time	5		6		ns
t _H	Register Hold Time	4		5		ns
t _{FSU}	Register Setup Time of Fast Input	2		2		ns
t _{FH}	Register Hold Time of Fast Input	2		2		ns
t _{RD}	Register Delay		2		2.5	ns
t _{COMB}	Combinatorial Delay		2		3	ns
t _{IC}	Array Clock Delay		6		7	ns
t _{EN}	Register Enable Time		6		7	ns
t _{GLOB}	Global Control Delay		2		3	ns
t _{PRE}	Register Preset Time		4		5	ns
t _{CLR}	Register Clear Time		4		5	ns
t _{UIM}	Switch Matrix Delay		2		2.5	ns
t _{RPA}	Reduced-power Adder ⁽²⁾		10		13	ns

Notes: 1. See ordering information for valid part numbers.

2. The t_{RPA} parameter must be added to the t_{LAD}, t_{LAC},t_{TIC}, t_{ACL}, and t_{SEXP} parameters for macrocells running in the reducedpower mode.

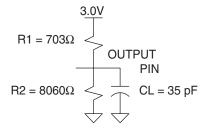
3. See ordering information for valid part numbers.

Input Test Waveforms and Measurement Levels



 t_R , t_F = 1.5 ns typical

Output AC Test Loads



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Power-down Mode

The ATF1504ASV(L) includes an optional pin-controlled power-down feature. When this mode is enabled, the PD pin acts as the power-down pin. When the PD pin is high, the device supply current is reduced to less than 3 mA. During power down, all output data and internal logic states are latched internally and held. Therefore, all registered and combinatorial output data remain valid. Any outputs that were in a High-Z state at the onset will remain at High-Z. During power down, all input signals except the power-down pin are blocked. Input and I/O hold latches remain active to ensure that pins do not float to indeterminate levels, further reducing system power. The power-down mode feature is enabled in the logic design file or as a fitted or translated s/w option. Designs using the power-down pin may not use the PD pin as a logic array input. However, all other PD pin macrocell resources may still be used, including the buried feedback and foldback product term array inputs.

		-15		-20			
Symbol	Parameter	Min	Max	Min	Max	Units	
t _{IVDH}	Valid I, I/O before PD High	15		20		ns	
t _{GVDH}	Valid OE ⁽²⁾ before PD High	15		20		ns	
t _{CVDH}	Valid Clock ⁽²⁾ before PD High	15		20		ns	
t _{DHIX}	I, I/O Don't Care after PD High		25		30	ns	
t _{DHGX}	OE ⁽²⁾ Don't Care after PD High		25		30	ns	
t _{DHCX}	Clock ⁽²⁾ Don't Care after PD High		25		30	ns	
t _{DLIV}	PD Low to Valid I, I/O		1		1	μs	
t _{DLGV}	PD Low to Valid OE (Pin or Term)		1		1	μs	
t _{DLCV}	PD Low to Valid Clock (Pin or Term)		1		1	μs	
t _{DLOV}	PD Low to Valid Output		1		1	μs	

Power Down AC Characteristics⁽¹⁾⁽²⁾

Notes: 1. For slow slew outputs, add t_{SSO}.

2. Pin or product term.

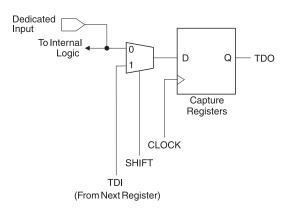
3. Includes t_{RPA} for reduced-power bit enabled.





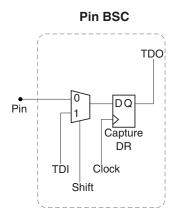
JTAG-BST/ISP Overview	The JTAG boundary-scan testing is controlled by the Test Access Port (TAP) controller in the ATF1504ASV(L). The boundary-scan technique involves the inclusion of a shift- register stage (contained in a boundary-scan cell) adjacent to each component so that signals at component boundaries can be controlled and observed using scan testing principles. Each input pin and I/O pin has its own boundary-scan cell (BSC) in order to support boundary-scan testing. The ATF1504ASV(L) does not currently include a Test Reset (TRST) input pin because the TAP controller is automatically reset at power-up. The five JTAG modes supported include: SAMPLE/PRELOAD, EXTEST, BYPASS, IDCODE and HIGHZ. The ATF1504ASV(L)'s ISP can be fully described using JTAG's BSDL as described in IEEE Standard 1149.1b. This allows ATF1504ASV(L) program- ming to be described and implemented using any one of the third-party development tools supporting this standard.
	The ATF1504ASV(L) has the option of using four JTAG-standard I/O pins for boundary- scan testing (BST) and in-system programming (ISP) purposes. The ATF1504ASV(L) is programmable through the four JTAG pins using the IEEE standard JTAG programming protocol established by IEEE Standard 1149.1 using 5V TTL-level programming signals from the ISP interface for in-system programming. The JTAG feature is a programmable option. If JTAG (BST or ISP) is not needed, then the four JTAG control pins are avail- able as I/O pins.
JTAG Boundary-scan Cell (BSC) Testing	The ATF1504ASV(L) contains up to 68 I/O pins and four input pins, depending on the device type and package type selected. Each input pin and I/O pin has its own bound- ary-scan cell (BSC) in order to support boundary-scan testing as described in detail by IEEE Standard 1149.1. A typical BSC consists of three capture registers or scan regis- ters and up to two update registers. There are two types of BSCs, one for input or I/O pin, and one for the macrocells. The BSCs in the device are chained together through the capture registers. Input to the capture register chain is fed in from the TDI pin while the output is directed to the TDO pin. Capture registers are used to capture active device data signals, to shift data in and out of the device and to load data into the update registers. Control signals are generated internally by the JTAG TAP controller. The BSC configuration for the input and I/O pins and macrocells are shown below.

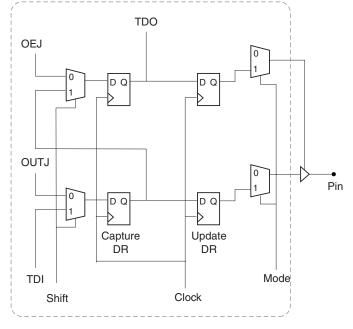
BSC Configuration for Input and I/O Pins (Except JTAG TAP Pins)



Note: The ATF1504ASV(L) has pull-up option on TMS and TDI pins. This feature is selected as a design option.

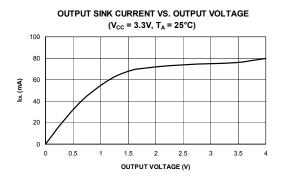
BSC Configuration for Macrocell



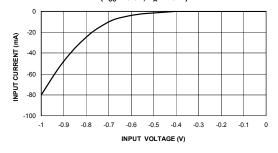


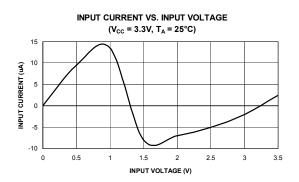
Macrocell BSC





INPUT CLAMP CURRENT VS. INPUT VOLTAGE (V_{CC} = 3.3V, T_A = 25°C)







t _{PD} (ns)	t _{co1} (ns)	f _{MAX} (MHz)	Ordering Code	Package	Operation Range
			ATF1504ASV-15 AU44	44A	Induction
15	8	100	ATF1504ASV-15 JU44	44J	Industrial (-40°C to +85°C)
			ATF1504ASV-15 AU100	100A	(-40 C t0 +85 C)
			ATF1504ASVL-20 AU44	44A	Industrial
20	20 12 83	12 83.3 ATF1504ASVL-20 JU44	ATF1504ASVL-20 JU44	44J	Industrial
		ATF1504ASVL-20 AU100	100A	(-40°C to +85°C)	

ATF1504ASV(L) Green Package Options (Pb/Halide-free/RoHS Compliant)

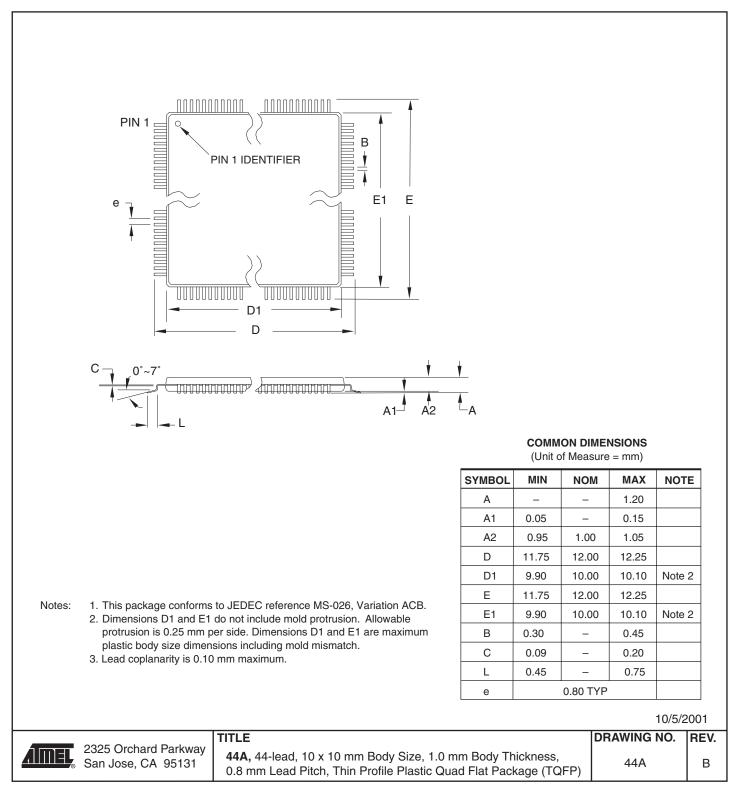
	Package Type
44 A	44-lead, Thin Plastic Gull Wing Quad Flatpack (TQFP)
44J	44-lead, Plastic J-leaded Chip Carrier (PLCC)
68J	68-lead, Plastic J-leaded Chip Carrier (PLCC)
84J	84-lead, Plastic J-leaded Chip Carrier (PLCC)
100Q1	100-lead, 14 x 20 mm Body, Plastic Quad Flat Package (PQFP)
100A	100-lead, 14 x 14 mm Body, Thin Profile Plastic Quad Flat Package (TQFP)





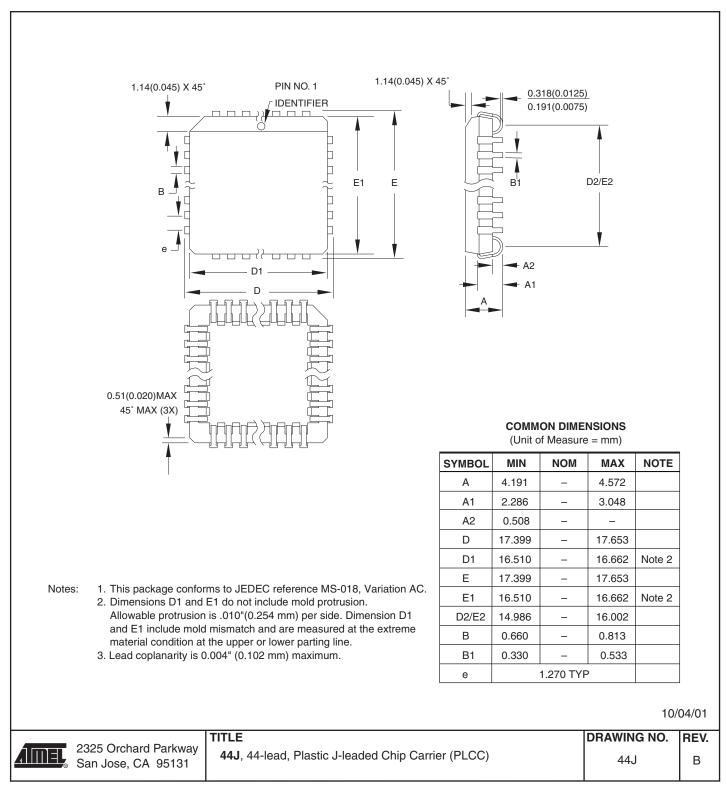
Packaging Information

44A – TQFP



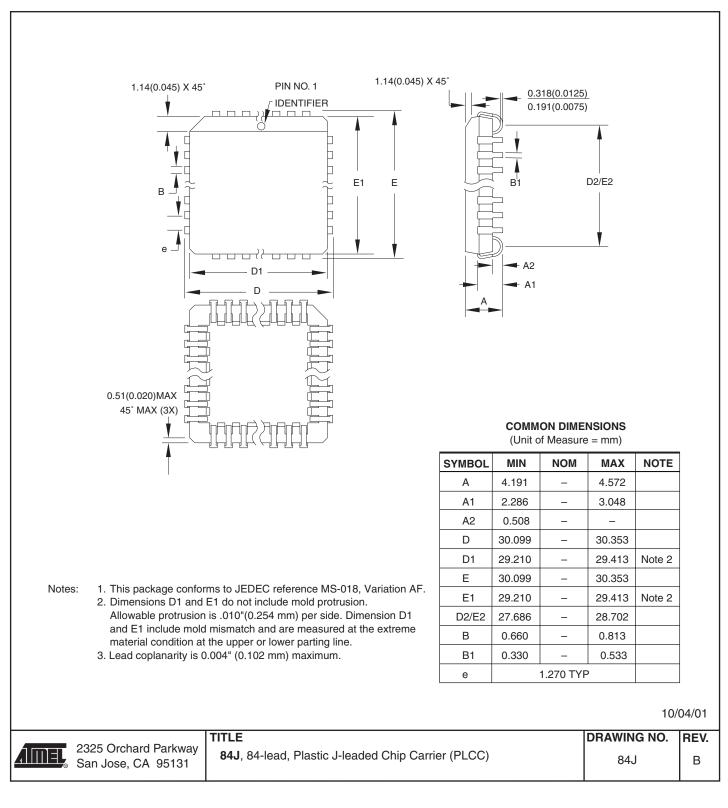
24 ATF1504ASV(L)

44J – PLCC





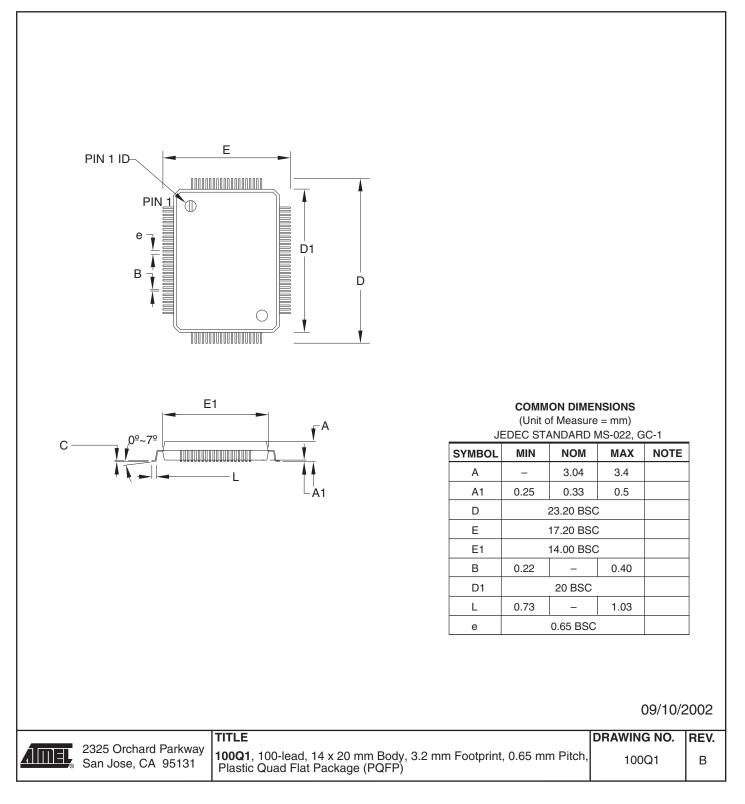
84J – PLCC



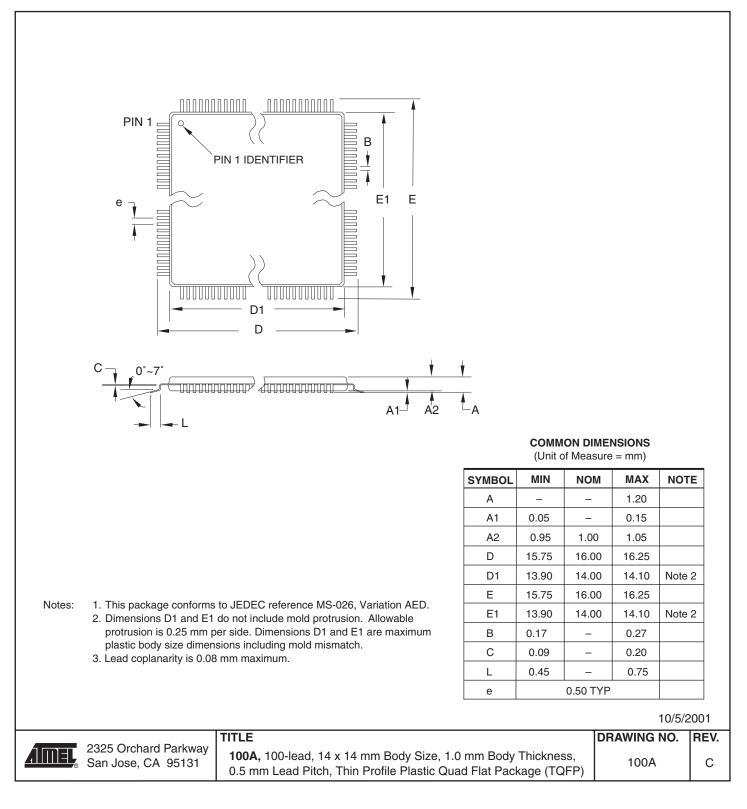




100Q1 - PQFP



100A – TQFP







Revision History

Revision	Comments
1409J	Green package options added.



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